

## Continental Device India Limited

An ISO/TS 16949 and ISO 9001 Certified Company



## SILICON PLANAR EPITAXIAL TRANSISTORS



CD931 PNP CD2331 NPN

TO-92 Plastic Package

## Low Frequency Amplifier and Medium Speed Switching

## **ABSOLUTE MAXIMUM RATINGS**

DESCRIPTION	SYMBOL	VALUE	UNITS
Collector Base Voltage	$V_{CBO}$	80	V
Collector Emitter Voltage	$V_{CEO}$	60	V
Emitter Base Voltage	$V_{EBO}$	8	V
Collector Current	I <sub>C</sub>	700	mA
Collector Power Dissipation @ T <sub>a</sub> =25°C	P <sub>C</sub>	0.9	W
Junction Temperature	T <sub>j</sub>	150	°C
Storage Temperature	T <sub>stg</sub>	- 55 to +150	°C

## ELECTRICAL CHARACTERISTICS (T<sub>2</sub>=25°C unless specified otherwise)

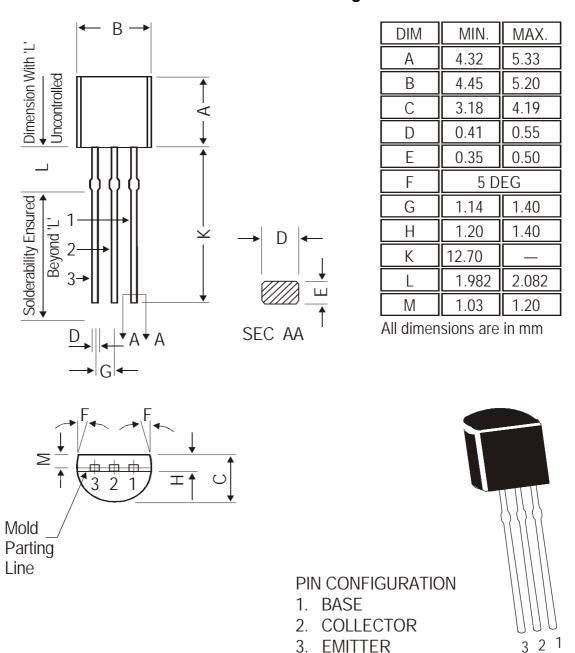
DESCRIPTION	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNITS
Collector Base Voltage	$V_{CBO}$	$I_{C}=100\mu A, I_{E}=0$	80			V
Collector Emitter Voltage	$V_{CEO}$	$I_C=10$ mA, $I_B=0$	60			V
Emitter Base Voltage	$V_{EBO}$	$I_E=10\mu A, I_C=0, NPN$	8			V
		$I_E=100\mu A, I_C=0, PNP$	8			V
Collector Cut Off Current	I <sub>CBO</sub>	$V_{CB} = 60V, I_{E} = 0$			0.1	μΑ
Emitter Cut Off Current	I <sub>EBO</sub>	$V_{EB} = 5V, I_{C} = 0$			0.1	μΑ
DC Current Gain	*h <sub>FE</sub>	$V_{CE}=2V$ , $I_{C}=50mA$	40		240	
Collector Emitter Saturation Voltage	*V <sub>CE (sat)</sub>	$I_C$ =500mA, $I_B$ =50mA			0.7	V
Base Emitter Saturation Voltage	*V <sub>BE (sat)</sub>	$I_C$ =500mA, $I_B$ =50mA			1.2	V
Transition Frequency	f⊤	$I_C=50$ mA, $V_{CE}=10$ V				
		NPN	30			MHz
		PNP		100		MHz
Output Capacitance	C <sub>ob</sub>	$I_E=0$ , $V_{CB}=10V$ , $f=1MHz$				
		NPN		8		pF
		PNP		13		pF

h <sub>FE</sub> Classification	CD2331	R:40-80,	O:70-140,	Y: 120 - 240	
					-
h <sub>FF</sub> Classification	CD931	R : 40 - 80.	O:70-140,	Y : 120 - 240	

<sup>\*</sup>Pulse Test: Pulse Width <300ms, Duty Cycle<2%

CD931\_CD2331Rev101103E

# **TO-92 Plastic Package**



The TO-92 Package, Tape and Ammo Pack Drawings are correct as on the date of issue/revision of this Data Sheet.

The currently valid dimensions and information, may please be confirmed from the TO-92 Drawing in the Packages and Packing Section of the Product Catalogue.

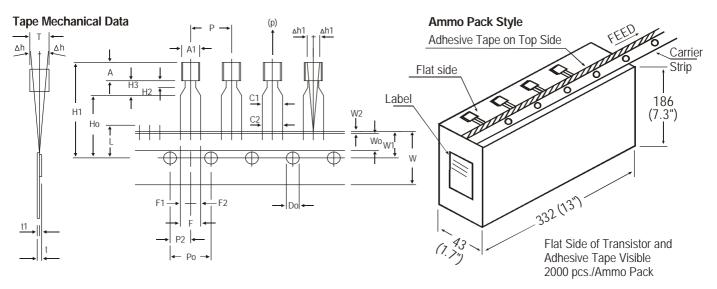
# Packing Details

PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX			
	Details	Net Weight/Qty	Size	Qty	Size	Qty	GrWt	
TO-92 Bulk	1K/polybag	200 gm/1K pcs	3" x 7.5" x 7.5"	5K	17" x 15" x 13.5"	80K	23 kgs	
TO-92 T&A	2K/ammo box	645 gm/2K pcs	12.5" x 8" x 1.8"	2K	17" x 15" x 13.5"	32K	12.5 kgs	

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# TO-92 Plastic Package

# **TO-92 Tape and Ammo Pack**



## All dimensions are in mm

		SPECIFICATION				
ITEM	SYMBOL	MIN.	NOM.	MAX.	TOL.	
BODY WIDTH	A1	4.0		4.8		
BODY HEIGHT	А	4.8		5.2		
BODY THICKNESS	Т	3.9		4.2		
PITCH OF COMPONENT	Р		12.7		± 1.0	
*1FEED HOLE PITCH	Po		12.7		± 0.3	
*2 FEED HOLE CENTRE TO						
COMPONENT CENTRE	P2		6.35		± 0.4	
DISTANCE BETWEEN OUTER LEADS	F		5.08		+ 0.6 - 0.2	
*3 COMPONENT ALIGNMENT SIDE VIEW	∆h		0	1.0		
*4 COMPONENT ALIGNMENT FRONT VIEW	△h1		0	1.3		
TAPE WIDTH	W		18		± 0.5	
HOLD-DOWN TAPE WIDTH	Wo		6		± 0.2	
HOLE POSITION	W1		9		+ 0.7	
					- 0.5	
HOLD-DOWN TAPE POSITION	W2		0.5		± 0.2	
LEAD WIRE CLINCH HEIGHT	Но		16		± 0.5	
COMPONENT HEIGHT	H1			23.25		
LENGTH OF SNIPPED LEADS	L			11.0		
FEED HOLE DIAMETER	Do		4		± 0.2	
*5 TOTAL TAPE THICKNESS	t			1.2		
LEAD - TO - LEAD DISTANCE	F1, F2		2.54		+ 0.4	
STAND OFF	H2	0.45		1.45	- 0.1	
CLINCH HEIGHT	H3			3.0		
LEAD PARALLELISM	C1 - C2			0.22		
PULL - OUT FORCE	(p)	6N				

#### **NOTES**

- 1. Maximum alignment deviation between leads will not to be greater than 0.2mm.
- 2. Maximum non-cumulative variation between tape feed holes shall not exceed 1 mm in 20 pitches.
- 3. Holddown tape will not exceed beyond the edge(s) of carrier tape and there shall be no exposure of adhesive.
- 4. There will be no more than three (3) consecutive missing components in a tape.
- 5. A tape trailer, having at least three feed holes are provided after the last component in a tape.
- 6. Splices should not interfere with the sprocket feed holes.

### **REMARKS**

- \*1 Cumulative pitch error 1.0 mm/20 pitch
- \*2 To be measured at bottom of clinch
- \*3 At top of body
- \*4 At top of body
- \*5 t1 0.3 0.6 mm

Notes CD931 PNP CD2331 NPN

TO-92 Plastic Package

### **Disclaimer**

The product information and the selection guides facilitate selection of the CDIL's Discrete Semiconductor Device(s) best suited for application in your product(s) as per your requirement. It is recommended that you completely review our Data Sheet(s) so as to confirm that the Device(s) meet functionality parameters for your application. The information furnished in the Data Sheet and on the CDIL Web Site/CD are believed to be accurate and reliable. CDIL however, does not assume responsibility for inaccuracies or incomplete information. Furthermore, CDIL does not assume liability whatsoever, arising out of the application or use of any CDIL product; neither does it convey any license under its patent rights nor rights of others. These products are not designed for use in life saving/support appliances or systems. CDIL customers selling these products (either as individual Discrete Semiconductor Devices or incorporated in their end products), in any life saving/support appliances or systems or applications do so at their own risk and CDIL will not be responsible for any damages resulting from such sale(s).

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